

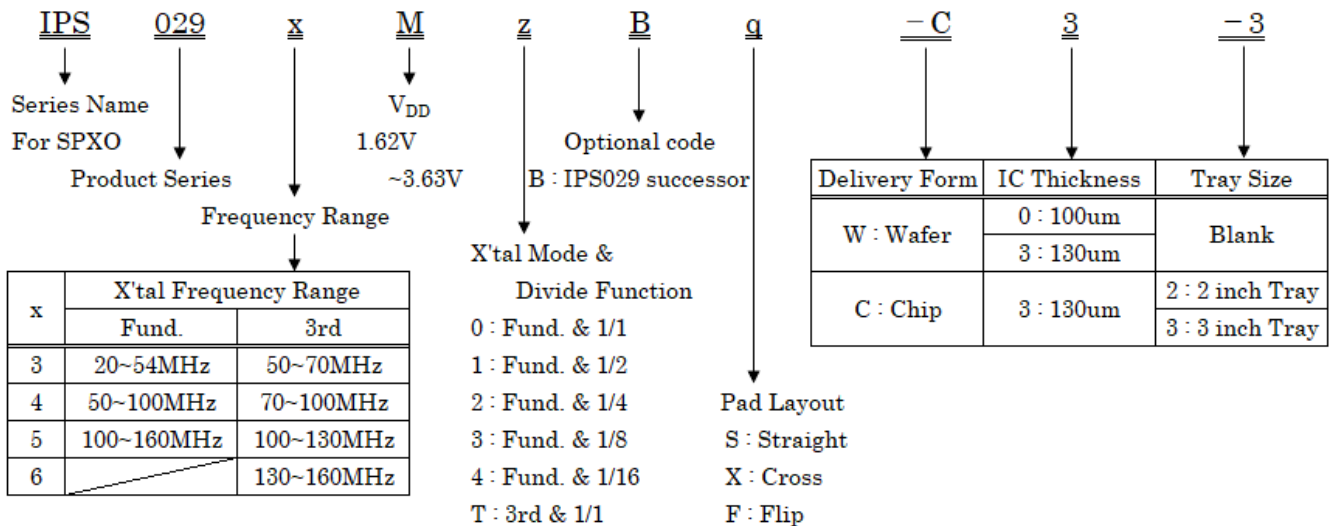
■ Description

IPS029*B series is the successor IC of IPS009BM series and IPS029xM series, for SPXO corresponding to the fundamental or 3rd overtone crystal from 20MHz to 160MHz. Chip size of this IC is small enough for 2016 size SMD. In addition, operation temperature is quite high (125°C) so IPS029xB can be used for various applications.

■ Features

- Operation temperature : -40°C~125°C
- Power supply voltage : 1.62V~3.63V
- Standby function : Oscillation stop
- Frequency range : 20MHz~160MHz
- Output : CMOS
- Crystal mode : Fundamental & 3rd overtone
- Small chip size : 0.56mm × 0.56mm
- Divider function : 1/2, 1/4, 1/8 and 1/16
- Duty cycle : Within 50%±5% (Except IPS0295MTBq & IPS0296MTBq)

1. Part number rule



2. Series

Part Number	Crystal Frequency f (MHz)		Crystal Mode	Divide	Output Frequency FO (MHz)		Remarks
	Min.	Max.			Min.	Max.	
IPS029 3 M 0 B q	20.00	54.00	Fund.	1/1	20.00	54.00	Pad layout q= S : Straight X : Cross F : Flip
IPS029 3 M 1 B q				1/2	10.00	27.00	
IPS029 3 M 2 B q				1/4	5.00	13.50	
IPS029 3 M 3 B q				1/8	2.50	6.75	
IPS029 3 M 4 B q				1/16	1.25	3.38	
IPS029 4 M 0 B q	50.00	100.00	Fund.	1/1	50.00	100.00	
IPS029 4 M 1 B q				1/2	25.00	50.00	
IPS029 4 M 2 B q				1/4	12.50	25.00	
IPS029 4 M 3 B q				1/8	6.25	12.50	
IPS029 4 M 4 B q				1/16	3.13	6.25	
IPS029 5 M 0 B q	100.00	160.00	Fund.	1/1	100.00	160.00	
IPS029 3 M T B q	50.00	70.00	3rd	1/1	50.00	70.00	
IPS029 4 M T B q	70.00	100.00		1/1	70.00	100.00	
IPS029 5 M T B q	100.00	130.00		1/1	100.00	130.00	
IPS029 6 M T B q	130.00	160.00		1/1	130.00	160.00	

3. Absolute Maximum Ratings

 $V_{SS}=0V, T_a=25^{\circ}C \pm 2^{\circ}C$

Parameter	Symbol	Condition	Ratings		
			Min	Max	Unit
Supply Voltage	V_{DD}		$V_{SS}-0.5$	5.0	V
Input Voltage	V_{IN}	All Input Pin	$V_{SS}-0.5$	$V_{DD}+0.5$	V
Output Voltage	V_{OUT}		$V_{SS}-0.5$	$V_{DD}+0.5$	V
Output Current	I_{OUT}			25	mA
Junction Temperature	T_j		-55	150	$^{\circ}C$
Storage Temperature	T_{stg}		-55	125	$^{\circ}C$

4. Recommended Operating Condition

 $V_{SS}=0V, T_a=-40^{\circ}C \sim 125^{\circ}C$

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
Supply Voltage	V_{DD}		1.62		3.63	V	V_{DD}
"H" Input Voltage	V_{IH}		$V_{DD} \times 0.8$			V	CE
"L" Input Voltage	V_{IL}				$V_{DD} \times 0.2$	V	CE
Input Voltage	V_{IN}		V_{SS}		V_{DD}	V	CE
Output Load Capacitance	CL	CMOS			15	pF	OUT
Ambient Temperature	T_{opt}		-40		125	$^{\circ}C$	

This IC has enough immunity against ESD and Latch-up, but handle with care.

5. Electrical Specification
5-1 Fundamental

 Unless otherwise stated, $V_{DD}=1.62V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 125^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
Output leak current	I_z	$CE=0V$, $X1=V_{DD}$ or V_{SS} $V_{out}=V_{SS}\sim V_{DD}$			10	μA
“H” output voltage	V_{OH}	$I_{OH}=-1.0mA$	$0.9V_{DD}$			V
“L” output voltage	V_{OL}	$I_{OL}=1.0mA$			$0.1V_{DD}$	V
Output Disable Time	T_{plz}				100	ns
Output Enable Time	T_{pzl}				2.0	ms
Oscillation start up time	T_{start}	$V_{DD}\geq 1.62V$			2.0	ms
Current consumption	I_{DD}	$CL=15pF$ IPS0293M0B, $f=27MHz$	$V_{DD}=1.8V$		2.3	mA
			$V_{DD}=3.3V$		4.2	
		$CL=15pF$ IPS0294M0B, $f=100MHz$	$V_{DD}=1.8V$		6.0	
			$V_{DD}=3.3V$		12.0	
		$CL=15pF$ IPS0295M0B, $f=160MHz$	$V_{DD}=1.8V$		14.0	
			$V_{DD}=3.3V$		20.0	
Current consumption at oscillation stop	I_{DDD}	$V_{DD}=3.3V$, $CE\leq 0.3V$			5.0	μA
Freq. V_{DD} deviation	F_{vst}	$V_{DD}=1.8V\pm 10\%$	IPS0293M0B		± 1.0	ppm
			IPS0294M0B		± 3.0	
		$V_{DD}=3.3V\pm 10\%$	IPS0293M0B		± 1.0	
			IPS0295M0B		± 2.0	
Output Duty Ratio	DUTY	$1/2V_{DD}$ point	45		55	%
Rise time / Fall time	T_r / T_f	$V_{DD}=1.62V\sim 2.25V$ $CL=15pF$ $10\%\sim 90\%V_{DD}$	IPS0293M0B		6.5	ns
			IPS0294M0B		5.0	
			IPS0295M0B		3.5	
		$V_{DD}=2.25V\sim 3.63V$ $CL=15pF$ $10\%\sim 90\%V_{DD}$	IPS0293M0B		4.0	
			IPS0294M0B		3.0	
			IPS0295M0B		2.0	

5-2 3rd Overtone

 Unless otherwise stated, $V_{DD}=1.62V\sim 3.63V$, $V_{SS}=0V$, $T_a=-40^{\circ}C\sim 125^{\circ}C$

Parameter	Symbol	Condition	Specification			Unit
			Min	Typ	Max	
Output leak current	I_z	$CE=0V$, $X1=V_{DD}$ or V_{SS} $V_{out}=V_{SS}\sim V_{DD}$			10	μA
“H” output voltage	V_{OH}	$I_{OH}=-1.0mA$	$0.9V_{DD}$			V
“L” output voltage	V_{OL}	$I_{OL}=1.0mA$			$0.1V_{DD}$	V
Output Disable Time	T_{plz}				100	ns
Output Enable Time	T_{pzl}				10.0	ms
Oscillation start up time	T_{start}	$V_{DD}\geq 1.62V$			10.0	ms
Current consumption	I_{DD}	$CL=15pF$ IPS0293MTB, $f=65MHz$	$V_{DD}=1.8V$		13.5	mA
			$V_{DD}=3.3V$		30.0	
		$CL=15pF$ IPS0294MTB, $f=100MHz$	$V_{DD}=1.8V$		15.0	
			$V_{DD}=3.3V$		32.5	
		$CL=15pF$ IPS0295MTB, $f=130MHz$	$V_{DD}=1.8V$		19.0	
			$V_{DD}=3.3V$		40.0	
		$CL=15pF$ IPS0296MTB, $f=160MHz$	$V_{DD}=1.8V$		24.5	
			$V_{DD}=3.3V$		47.0	
Current consumption at oscillation stop	I_{DDD}	$V_{DD}=3.3V$, $CE\leq 0.3V$			5.0	μA
Freq. V_{DD} deviation	F_{vst}	$V_{DD}=1.8V\pm 10\%$	IPS0293MTB IPS0294MTB		± 1.0	ppm
			IPS0295MTB IPS0296MTB		± 2.0	
		$V_{DD}=3.3V\pm 10\%$	All Models		± 1.0	
Output Duty Ratio	DUTY	$1/2V_{DD}$ point $-40^{\circ}C\sim 125^{\circ}C$	IPS0293MTB IPS0294MTB	45	55	%
		$1/2V_{DD}$ point $-40^{\circ}C\sim 85^{\circ}C$	IPS0295MTB IPS0296MTB	45	55	
		$1/2V_{DD}$ point $85^{\circ}C\sim 125^{\circ}C$	IPS0295MTB IPS0296MTB	40	60	
Rise time / Fall time	T_r / T_f	$V_{DD}=1.62V\sim 2.25V$ $CL=15pF$ $10\%\sim 90\%V_{DD}$	IPS0293MTB		6.5	ns
			IPS0294MTB		5.0	
			IPS0295MTB		3.5	
			IPS0296MTB		3.5	
		$V_{DD}=2.25V\sim 3.63V$ $CL=15pF$ $10\%\sim 90\%V_{DD}$	IPS0293MTB		4.0	
			IPS0294MTB		3.0	
			IPS0295MTB		2.0	
			IPS0296MTB		2.0	

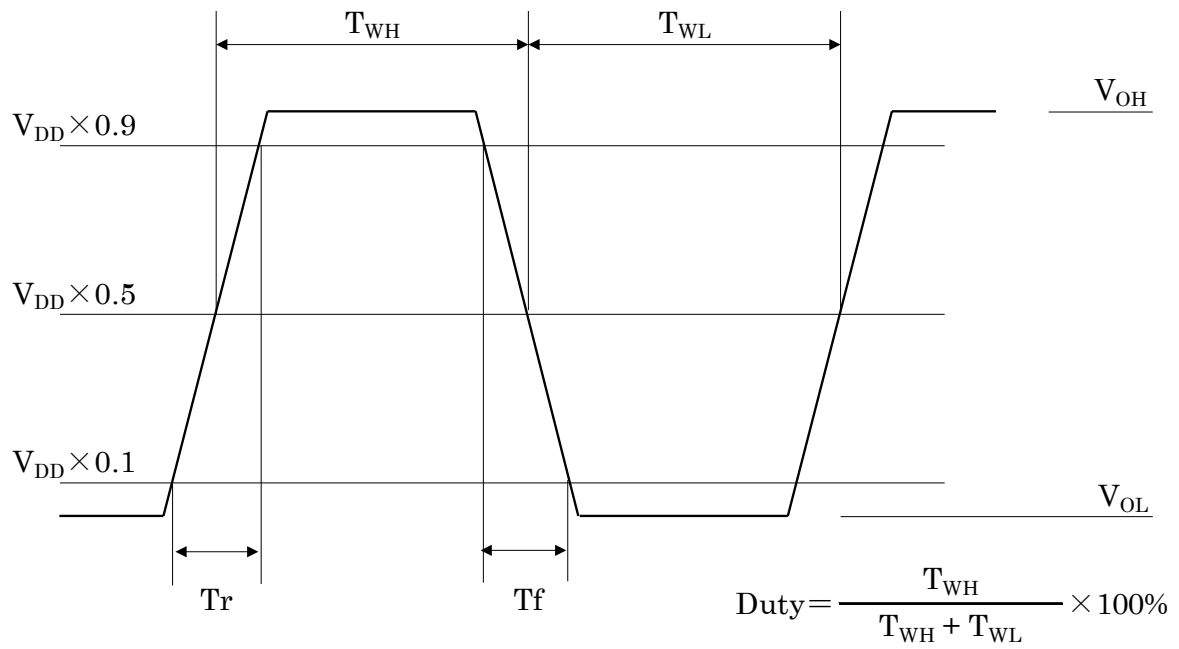
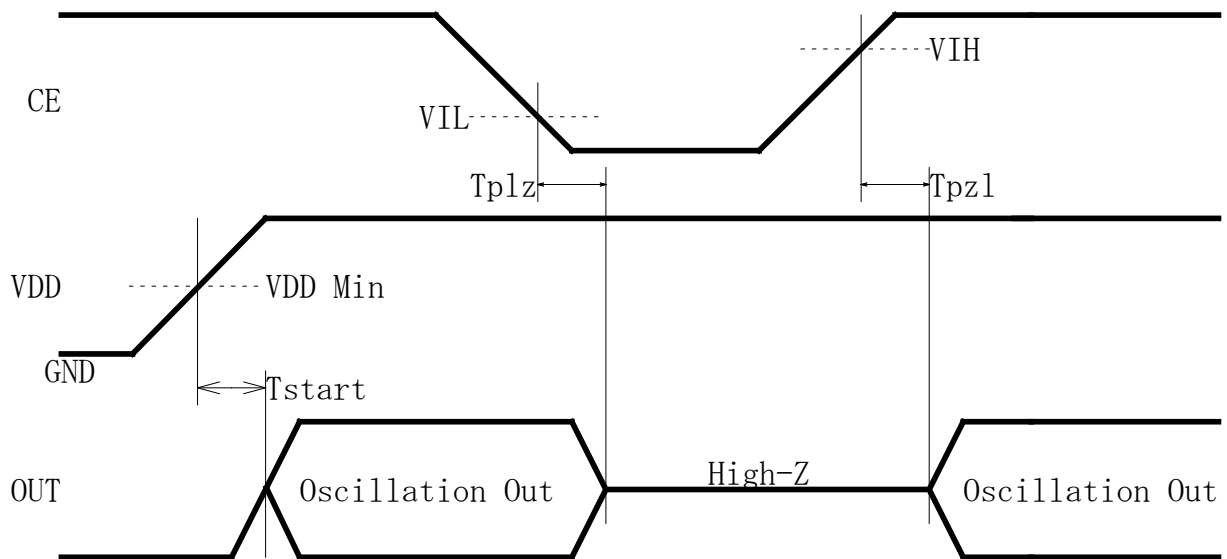


Fig. 5-1 Output Wave Form (Duty, Tr, Tf, V_{OH}, V_{OL})



V_{IH} : Threshold voltage for Oscillation Start
 V_{IL} : Threshold voltage for Oscillation Stop

Fig. 5-2 Input output signal timing

6. Circuit Parameters of Oscillator (Reference Data for Circuit Design)

Ta=25°C

Parameter		Symbol	Condition	Min	Typ	Max	Unit
Feedback Resistor	IPS029xMzB (z=0, 1, 2, 3, 4)	Rf	Refer to Fig. 6-1		300		kΩ
	IPS0293MTB				4.0		
	IPS0294MTB				3.0		
	IPS0295MTB				2.5		
	IPS0296MTB				1.96		
Driving Resistor	IPS0293MzB (z=0, 1, 2, 3, 4)	Rd	Refer to Fig. 6-1		1000		Ω
	IPS0294MzB (z=0, 1, 2, 3, 4)				750		
	IPS0295M0B				250		
	IPS0293MTB				500		
	IPS0294MTB				250		
	IPS0295MTB				250		
	IPS0296MTB				125		
Oscillation Capacitor	IPS0293MzB (z=0, 1, 2, 3, 4)	Cg	Refer to Fig. 6-1		5.0		pF
		Cd			12.0		
	IPS0294MzB (z=0, 1, 2, 3, 4)	Cg			4.0		
		Cd			7.0		
	IPS0295M0B	Cg			4.0		
		Cd			6.0		
	IPS0293MTB	Cg			8.0		
		Cd			10.0		
	IPS0294MTB	Cg			5.0		
		Cd			9.0		
	IPS0295MTB	Cg			4.0		
		Cd			8.0		
	IPS0296MTB	Cg			3.0		
		Cd			8.0		

*The above values are the design values and are not guaranteed by test.

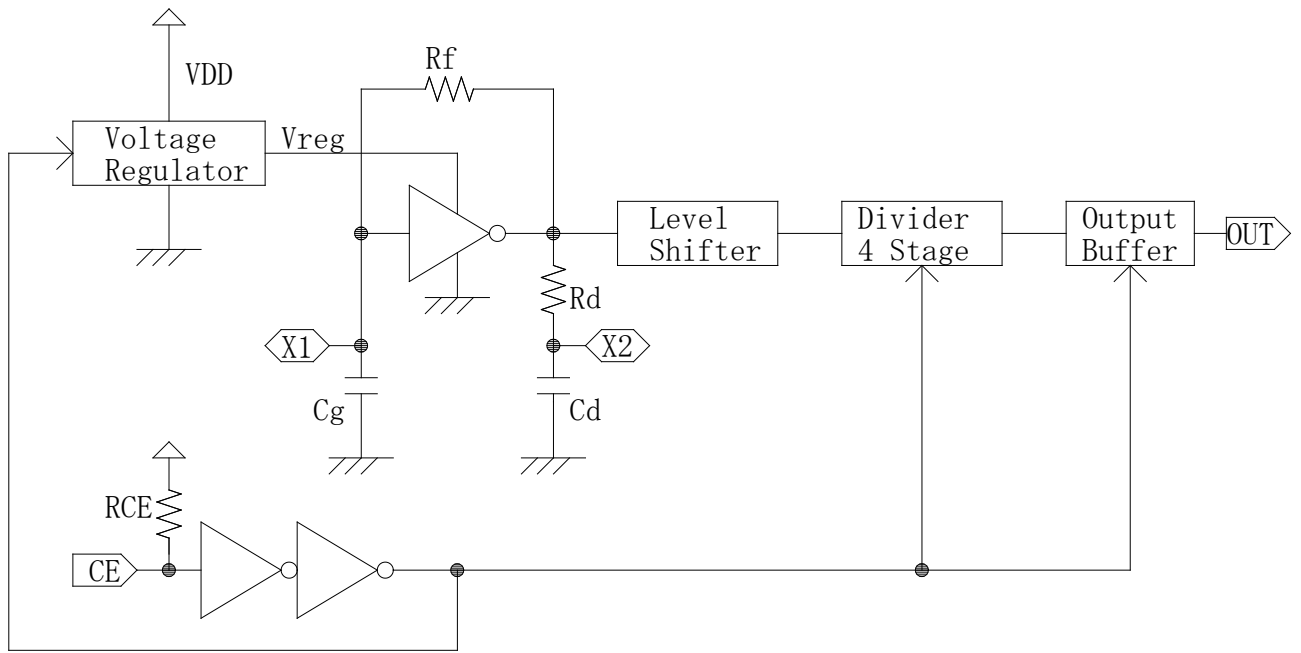
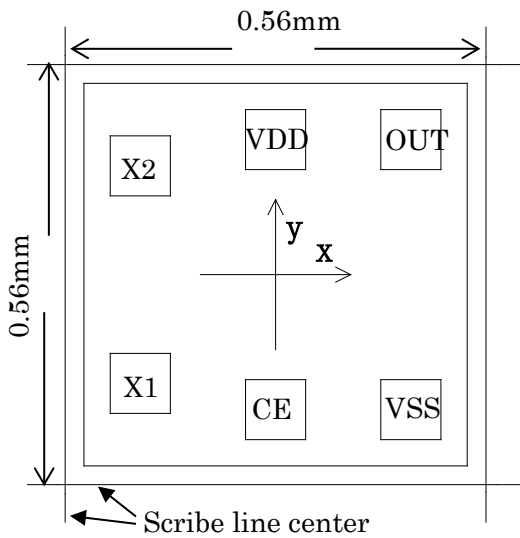


Fig. 6-1 Block Diagram

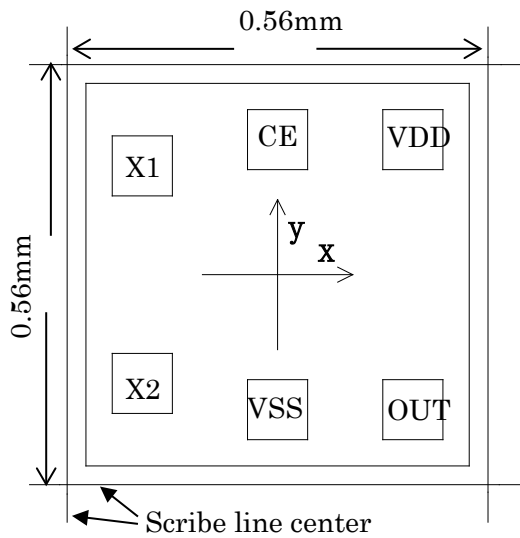
7. Pad Layout

7-1 Straight Type



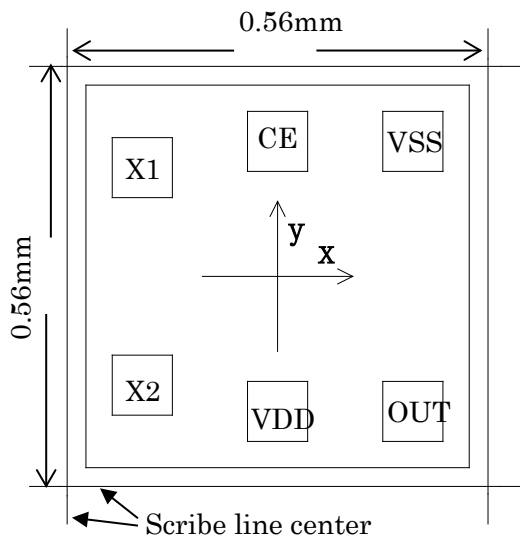
- Die Size: 0.56mm × 0.56mm
- Pad Size: 80um □
- Thickness: 100um or 130um±10um
- IC Backside: Gnd or Open

Pad Name	Function	Location (μm)	
		x	y
X1	Crystal Feedback	-181.00	-143.15
CE	Oscillation stop "L": High-Impedance	0.00	-180.55
VSS	(-) Ground	181.00	-180.55
OUT(Q)	Frequency Output	181.00	180.55
VDD	(+) Power Supply	0.00	180.55
X2	Crystal Drive	-181.00	143.15
Chip Center		0	0

7-2 Cross Type


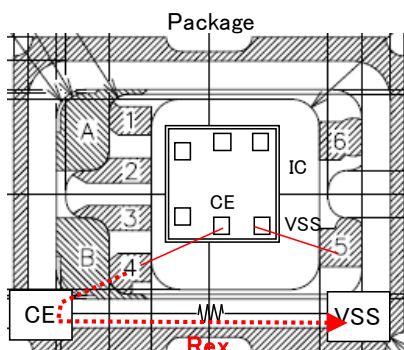
- Die Size: 0.56mm × 0.56mm
- Pad Size: 80um □
- Thickness: 100um or 130um±10um
- IC Backside: Gnd or Open

Pad Name	Function	Location (μm)	
		x	y
X2	Crystal Drive	-181.00	-143.15
VSS	(-) Ground	0.00	-180.55
OUT(Q)	Frequency Output	181.00	-180.55
VDD	(+) Power Supply	181.00	180.55
CE	Oscillation stop "L": High-Impedance	0.00	180.55
X1	Crystal Feedback	-181.00	143.15
Chip Center		0	0

7-3 Flip Type


- Die Size: 0.56mm × 0.56mm
- Pad Size: 80um □
- Thickness: 100um or 130um±10um
- IC Backside: Gnd or Open

Pad Name	Function	Location (μm)	
		x	y
X2	Crystal Drive	-181.00	-143.15
VDD	(+) Power Supply	0.00	-180.55
OUT(Q)	Frequency Output	181.00	-180.55
VSS	(-) Ground	181.00	180.55
CE	Oscillation stop "L": High-Impedance	0.00	180.55
X1	Crystal Feedback	-181.00	143.15
Chip Center		0	0


IMPORTANT Notice for CE function

- ※ Oscillation will not be activated when CE=Open after CE=Low if Rex is not large.
- ※ Reference value of Rex is over 10MΩ with CE=Open usage.
- ※ There is no such issue with CE=VDD usage.

Rex : Resistance value between CE and VSS of package